

ALPHA® OM-347 Solder Paste

Ultra-Cleanable, No-Clean, Lead-Free, Zero-Halogen, Ultra-Fine Feature Printing & Reflow Capable

DESCRIPTION

ALPHA OM-347 is designed for print and reflow with Type 4 and Type 5 powder for applications requiring ultra-fine feature performance. It has been formulated to enable excellent cleaning of residues after PCBs have been reflowed. Residues can be cleaned with industry leading cleaning chemistries and in a static bath using nPB solvents.

ALPHA OM-347 has an outstanding reflow process window that delivers good soldering on CuOSP with excellent coalescence on a broad range of deposit sizes, excellent random solder ball and mid-chip solder ball resistance.

READ ENTIRE TECHNICAL DATA SHEET BEFORE USING THIS PRODUCT

FEATURES & BENEFITS

- No-Clean & Ultra-Clean: ALPHA OM-347 is a no-clean solder paste; residue resulted after the reflow process can be safely left on board. If needed, the residue can be very easy cleaned with Aquanox A4241, ALPHA BC-3350, or nPB based solvents.
- HIP performance: very good HIP performance, comparable with ALPHA OM-340
- High Tack Force Life: ensures high pick-and-place yields, good self-alignment
- Long Stencil Life: engineered for consistent performance, reducing variations in print performance and paste dry-out
- Wide Reflow Profile Window: enables quality soldering of complex, high density PCB assemblies in both air and N2
- Excellent Coalescence and Wetting Performance: coalesces well for down to 100µ using 50µ stencil, N2 reflow low soak profile environment
- Excellent Solder Joint and Flux Residue Cosmetics: residue does not char or burn after reflow soldering, even when using long/high thermal soaking
- Excellent Voiding Performance: Pass IPC-7095 Class 3 requirement for BGA.
- Halogen Content: Zero-Halogen
- Safe and Environmentally Friendly: Materials comply with ROHS, TOSCA, EINECS and Zero-Halogen requirements







PRODUCT INFORMATION

Alloys: SAC305 & Sn96Ag4, other alloys available on request

Powder Size: IPC Type 4 & Type 5

Packaging Sizes: 500 gram jars, 6in & 12in cartridges

Flux Gel: ALPHA OM-347 Flux

<u>Lead Free</u>: RoHS Directive EU/2015/863; amending Annex II of 2011/65/EU.

TECHNICAL DATA

Category	Results	Procedures/Remarks	
Chemical Properties			
Activity Level	ROM0	IPC J-STD-004B	
Halide Content	Halide free (by titration), < 0.05%	IPC J-STD-004B	
Fluoride Spot Test	Pass	JIS Z 3197:1999 8.1.4.2.4	
Halogen Test	Pass, Zero Halogen - No halogen intentionally added	EN14582, by oxygen bomb combustion, Non-detectable (ND) at < 50 ppm	
Electrical Properties			
SIR (7 days, 40 °C/90%RH, 12 V	Dana	IPC J-STD-004B TM-650 2.6.3.7	
bias)	Pass	(Pass ≥ 1 x 10 ⁸ oh	
Physical Properties			
Color	Clear, Colorless Flux Residue		
Took Force vo. Humidity	Pass	JIS Z 3284:1994, Annex 9	
Tack Force vs. Humidity	Pass	IPC J-STD-005 TM-650 2.4.44	
Viscosity Stability at 25 °C for 14 days	Pass	Malcom Spiral Viscometer	
Coalescence Test -, 50µm stencil , N ₂ reflow low soak profile environment	100 μm	Internal Test Method	
Solder Ball	Preferred	IPC J-STD-005B TM-650 2.4.43	
Spread	>80%	JIS Z 3198-3	
Residue Dryness	Residue is not sticky	Internal Dryness Test	
Stencil Life	>8 hours	@ 50% RH 23 °C (74 °C)	
Hot Slump	No bridge for 0.2 mm space	IPC J-STD-005 TM-650 2.4.35	







PROCESSING GUIDELINES

	Storage & Handling	Printing	Reflow	Cleaning
1.	Refrigerate to guarantee stability @ 0 to 10 °C (32 to 50 °F). When stored under these conditions, the shelf life of ALPHA OM-347 is 6 months.	Stencil: Recommend ALPHA CUT, ALPHA NICKEL-CUT, ALPHA TETRABOND®, or ALPHA FORM stencils @	Atmosphere: Cleandry air or nitrogen atmosphere. Profile:	ALPHA OM-347 residue is designed to remain on the board after reflow. If post reflow residue
2.	Paste can be stored for 2 weeks at room temperature up to 25 °C (77 °F) prior to use	0.100 to 0.150 mm (4 to 6 mil) thick for 0.4 to 0.5 mm (0.016" or 0.020") pitch. Stencil design is	Soak: 130 to 200 °C 90 to 110 sec soak, 240 °C Peak, 60Sec	a broad range of cleaners may be used. Alpha
3.	When refrigerated, warm up paste container to room temperature for up to 4 hours. Paste must be 19 °C (66 °F)	subject to many process variables. Contact your local Alpha stencil site for advice.	TAL profiles have been determined to give optimal results	recommends ALPHA BC-3350, Aquanox A4241 & nPB based solvents.
	before processing. Verify paste temperature with a	Squeegee: Metal (recommended)	Note 1: This is a suggested reflow	For best cleaning
	thermometer to ensure paste is at 19 °C (66 °F) or greater before set up of printer.	Pressure: 0.21 to 0.36 kg/cm of blade (1.25 to 2.0 lbs/inch)	profile. Desired results may be achieved using other	results, Alpha suggests using some agitation
4.	Paste can be manually stirred before use. A rotating / Centrifugal force mixing operation is not required. If a	Speed: 25 to 150 mm per second (1 to 6 inches per second).	profiles.	(mechanical stirring, ultrasonic bath, etc.) to clean ALPHA OM-347 residue
	rotating/centrifugal force mixing is used, 30 to 60 seconds at 300 RPM is adequate.	Paste Roll: 1.5 to 2.0 cm diameter and make additions when roll reaches 1 to cm (0.4")		reflowed in air.
5.	Do not remove worked paste from stencil and mix with unused paste in jar. This will	diameter (min). Max roll size will depend upon blade.		
6.	alter the rheology of unused paste. These are starting	Stencil Release Speed: 1 to 5 mm/sec.		
	recommendations and all process settings should be reviewed independently.	Lift Height: 8 to 14mm (0.31 to 0.55")		



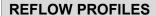




Fig 1: Suggested Soak Reflow Profile

RECYCLING SERVICES

We provide safe and efficient recycling services to help companies meet their environmental and legislative requirements and at the same time, maximize the value of their waste streams.

Our service collects solder dross, solder scrap, and various forms of solder paste waste. Please contact your local sales representative for recycling capabilities in your area or <u>link here</u>.







SAFETY & WARNING

It is recommended that the company/operator read and review the Safety Data Sheets for the appropriate health and safety warnings before use. **Safety Data Sheets are available at MacdermidAlpha.com/assembly-solutions/knowledge-base.**

CONTACT INFORMATION

To confirm this document is the most recent version, please contact Assembly@MacDermidAlpha.com

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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency safety directory assistance: US 1 202 464 2554, Europe + 44 1235 239 670, Asia + 65 3158 1074, Brazil 0800 707 7022 and 0800 172 020, Mexico 01800 002 1400 and (55) 5559 1588

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